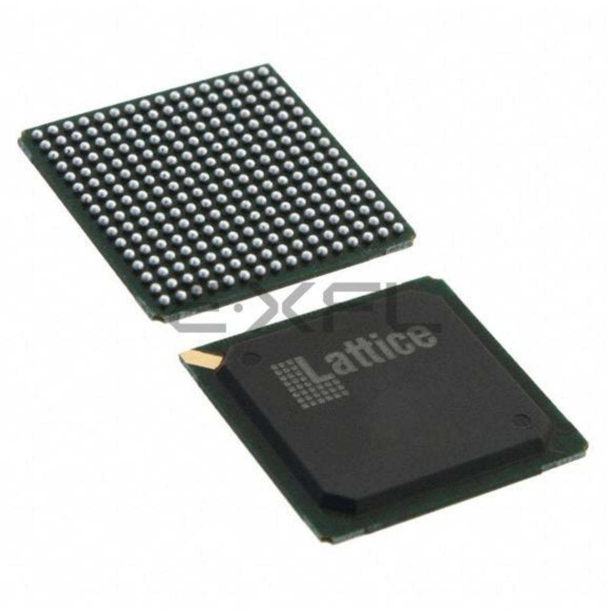

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details	
Product Status	Obsolete
Number of LABs/CLBs	1500
Number of Logic Elements/Cells	12000
Total RAM Bits	226304
Number of I/O	193
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-12se-7f256c

Delay Locked Loops (DLL)

In addition to PLLs, the LatticeECP2/M family of devices has two DLLs per device.

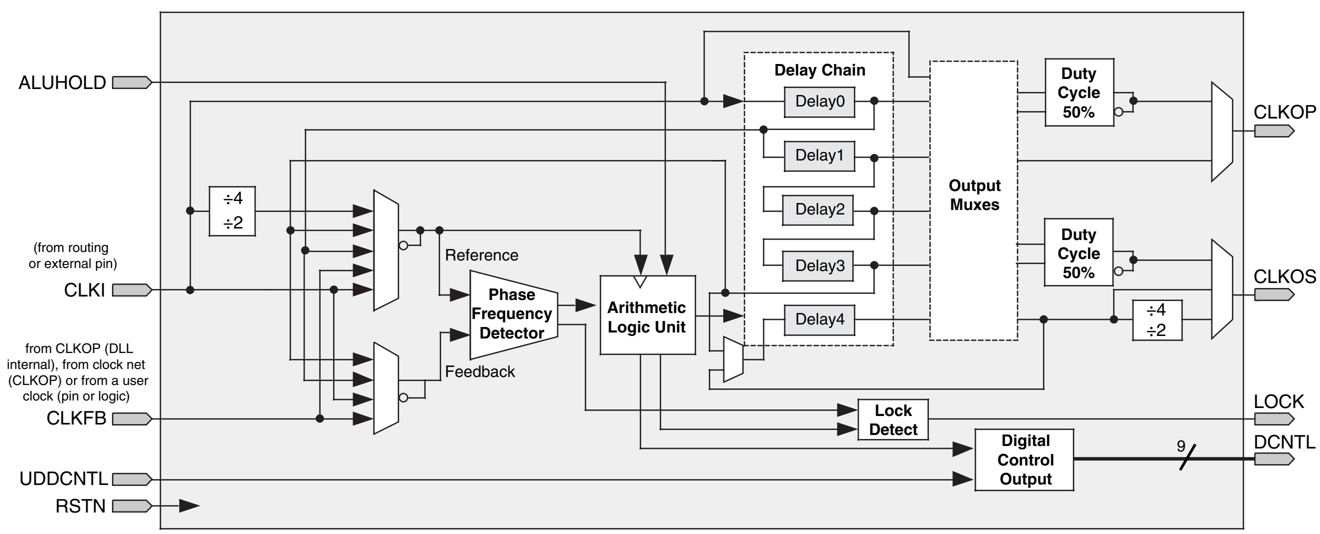
CLKI is the input frequency (generated either from the pin or routing) for the DLL. CLKI feeds into the output muxes block to bypass the DLL, directly to the DELAY CHAIN block and (directly or through divider circuit) to the reference input of the Phase Frequency Detector (PFD) input mux. The reference signal for the PFD can also be generated from the Delay Chain and CLKFB signals. The feedback input to the PFD is generated from the CLKFB pin, CLKI or from tapped signal from the Delay chain.

The PFD produces a binary number proportional to the phase and frequency difference between the reference and feedback signals. This binary output of the PFD is fed into a Arithmetic Logic Unit (ALU). Based on these inputs, the ALU determines the correct digital control codes to send to the delay chain in order to better match the reference and feedback signals. This digital code from the ALU is also transmitted via the Digital Control bus (DCNTL) bus to its associated DLLDELA delay block. The ALUHOLD input allows the user to suspend the ALU output at its current value. The UDDCNTL signal allows the user to latch the current value on the DCNTL bus.

The DLL has two independent clock outputs, CLKOP and CLKOS. These outputs can individually select one of the outputs from the tapped delay line. The CLKOS has optional fine phase shift and divider blocks to allow this output to be further modified, if required. The fine phase shift block allows the CLKOS output to phase shifted a further 45, 22.5 or 11.25 degrees relative to its normal position. Both the CLKOS and CLKOP outputs are available with optional duty cycle correction. Divide by two and divide by four frequencies are available at CLKOS. The LOCK output signal is asserted when the DLL is locked. Figure 2-6 shows the DLL block diagram and Table 2-5 provides a description of the DLL inputs and outputs.

The user can configure the DLL for many common functions such as time reference delay mode and clock injection removal mode. Lattice provides primitives in its design tools for these functions. For more information about the DLL, please see the list of additional technical documentation at the end of this data sheet.

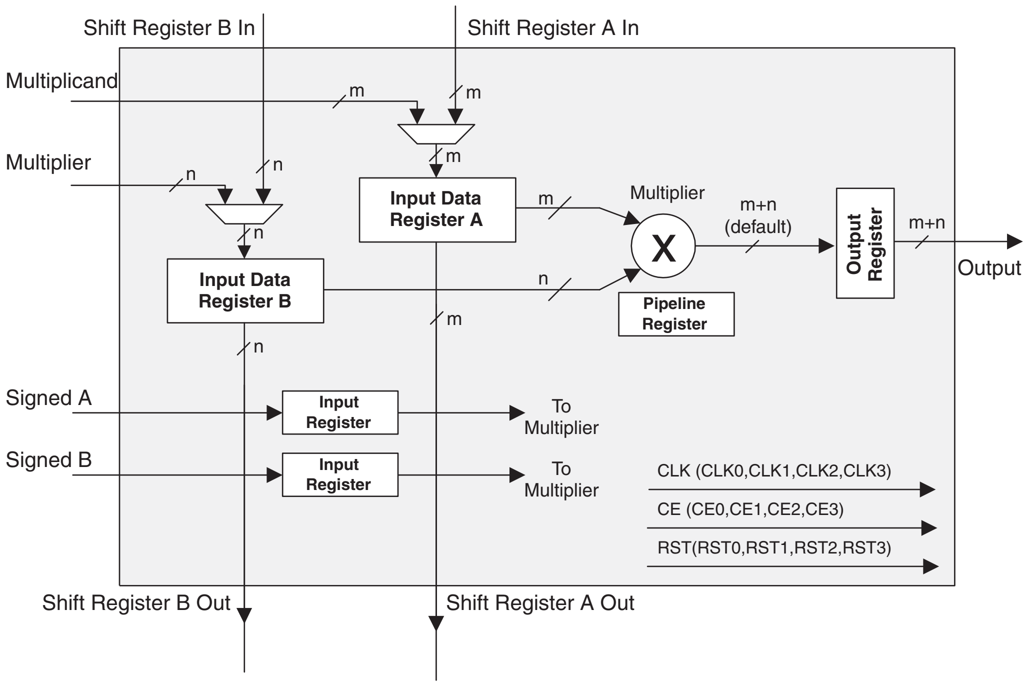
Figure 2-6. Delay Locked Loop Diagram (DLL)



MULT sysDSP Element

This multiplier element implements a multiply with no addition or accumulator nodes. The two operands, A and B, are multiplied and the result is available at the output. The user can enable the input/output and pipeline registers. Figure 2-23 shows the MULT sysDSP element.

Figure 2-23. MULT sysDSP Element



MAC sysDSP Element

In this case, the two operands, A and B, are multiplied and the result is added with the previous accumulated value. This accumulated value is available at the output. The user can enable the input and pipeline registers, but the output register is always enabled. The output register is used to store the accumulated value. The Accumulators in the DSP blocks in the LatticeECP2/M family can be initialized dynamically. A registered overflow signal is also available. The overflow conditions are provided later in this document. Figure 2-24 shows the MAC sysDSP element.

Figure 2-24. MAC sysDSP

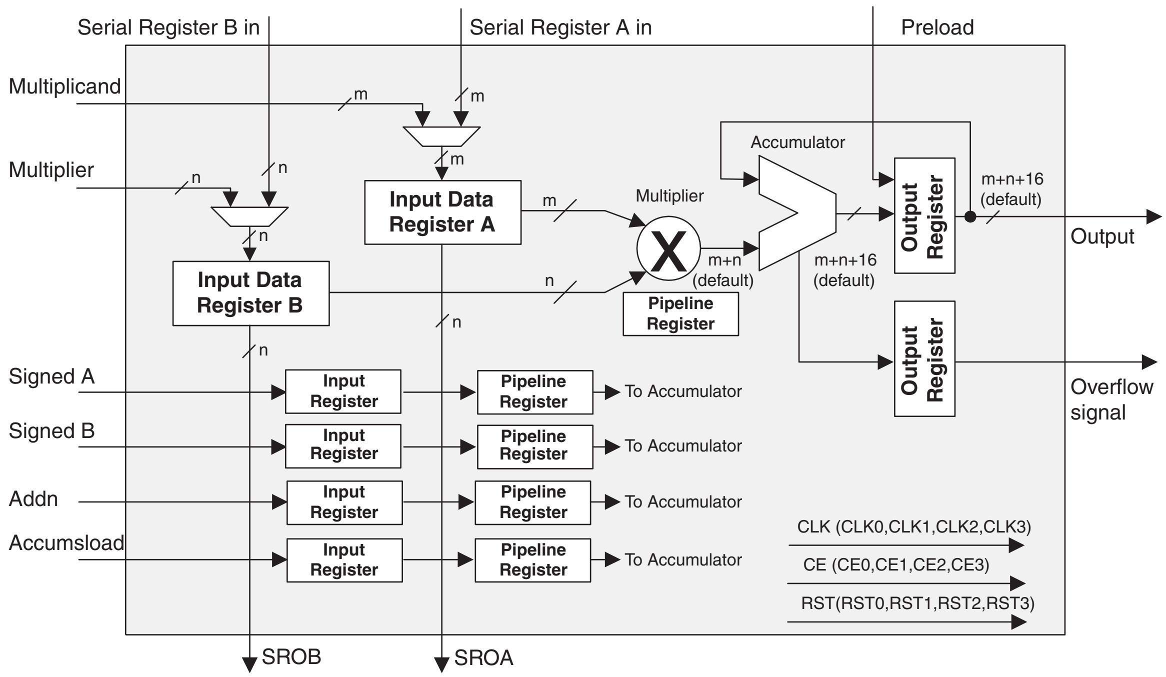
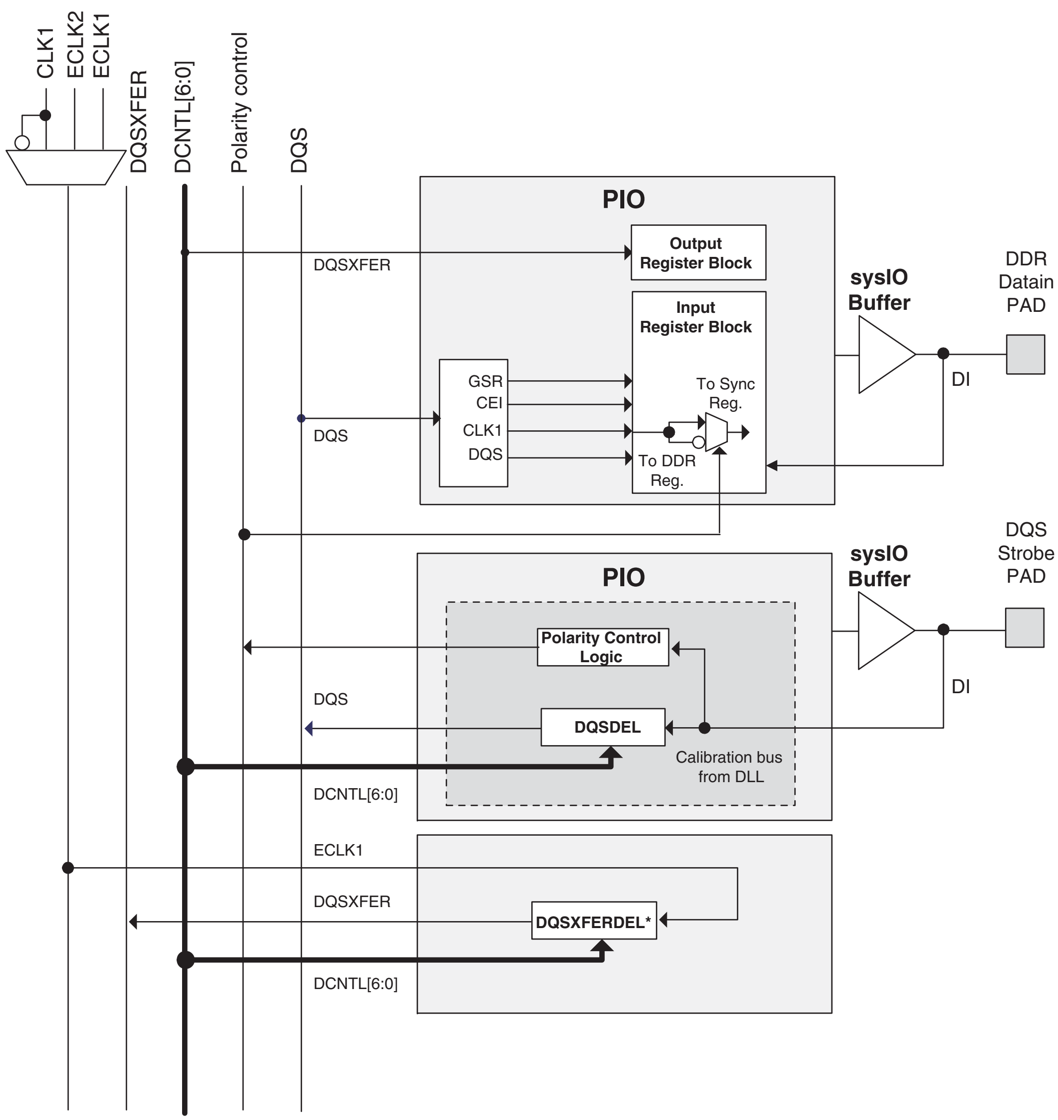


Figure 2-36. DQS Local Bus



*DQSXFERDEL shifts ECLK1 by 90% and is not associated with a particular PIO.

Polarity Control Logic

In a typical DDR Memory interface design, the phase relationship between the incoming delayed DQS strobe and the internal system clock (during the READ cycle) is unknown.

The LatticeECP2/M family contains dedicated circuits to transfer data between these domains. To prevent set-up and hold violations, at the domain transfer between DQS (delayed) and the system clock, a clock polarity selector is used. This changes the edge on which the data is registered in the synchronizing registers in the input register block. This requires evaluation at the start of each READ cycle for the correct clock polarity.

Prior to the READ operation in DDR memories, DQS is in tristate (pulled by termination). The DDR memory device drives DQS low at the start of the preamble state. A dedicated circuit detects the first DQS rising edge after the pre-amble state. This signal is used to control the polarity of the clock to the synchronizing registers.

SERDES and PCS (Physical Coding Sublayer)

LatticeECP2M devices feature up to 16 channels of embedded SERDES arranged in quads at the corners of the devices. Figure 2-39 shows the position of the quad blocks in relation to the PFU array for LatticeECP2M70 and LatticeECP2M100 devices. Table 2-15 shows the location of Quads for all the devices.

Each quad contains four dedicated SERDES (Ch0 to Ch3) for high-speed, full-duplex serial data transfer. Each quad also has a PCS block that interfaces to the SERDES channels and contains digital logic to support an array of popular data protocols. PCS also contains logic to the interface to FPGA core.

Figure 2-39. SERDES Quads (LatticeECP2M70/LatticeECP2M100)

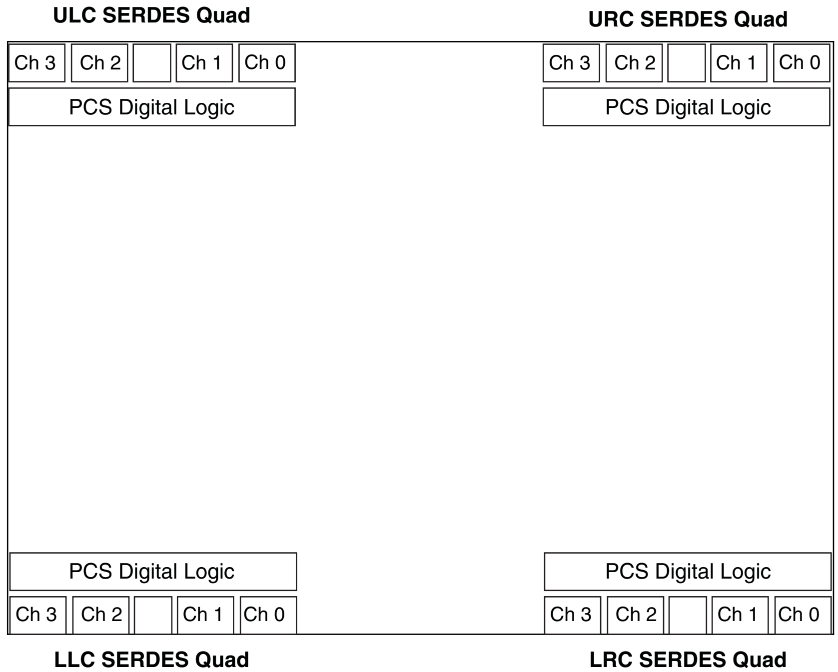


Table 2-15. Available SERDES Quads per LatticeECP2M Devices

Device	URC Quad	ULC Quad	LRC Quad	LLC Quad
ECP2M20	Available	—	—	—
ECP2M35	Available	—	—	—
ECP2M50	Available	—	Available	—
ECP2M70	Available	Available	Available	Available
ECP2M100	Available	Available	Available	Available

SERDES Block

A differential receiver receives the serial encoded data stream, equalizes the signal, extracts the buried clock and de-serializes the data-stream before passing the 8- or 10-bit data to the PCS logic. The transmit channel receives the parallel (8- or 10-bit) encoded data, serializes the data and transmits the serial bit stream through the differential buffers. There is a single transmit clock per quad. Figure 2-40 shows a single channel SERDES and its interface to the PCS logic. Each SERDES receiver channel provides a recovered clock to the PCS block and to the FPGA core logic.

LatticeECP2 Initialization Supply Current[1, 2, 3, 4]

Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ.[5, 6, 7]	Units
I_{CC}	Core Power Supply Current	ECP2-6	34	mA
		ECP2-12	54	mA
		ECP2-20	82	mA
		ECP2-35	135	mA
		ECP2-50	187	mA
		ECP2-70	267	mA
I_{CCAUX}	Auxiliary Power Supply Current	ECP2-6	30	mA
		ECP2-12	30	mA
		ECP2-20	30	mA
		ECP2-35	30	mA
		ECP2-50	30	mA
		ECP2-70	30	mA
I_{CCGPLL}	GPLL Power Supply Current (per GPLL)	ECP2-35, -50, -70 Only	0.5	mA
I_{CCSPLL}	SPLL Power Supply Current (per SPLL)	ECP2-35, -50, -70 Only	0.5	mA
I_{CCIO}	Bank Power Supply Current (per Bank)	All Devices	3	mA
I_{CCJ}	VCCJ Power Supply Current	All Devices	4	mA

1. Until DONE signal is active.
2. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.
3. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.
4. Frequency 0MHz.
5. T_J = 25°C, power supplies at nominal voltage.
6. A specific configuration pattern is used that scales with the size of the device; consists of 75% PFU utilization, 50% EBR, and 25% I/O configuration.
7. Values shown in this column are the typical average DC current during configuration. Use the Power Calculator tool to find the peak startup current.

MLVDS

The LatticeECP2/M devices support the differential MLVDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The MLVDS input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-5 is one possible solution for MLVDS standard implementation. Resistor values in Figure 3-5 are industry standard values for 1% resistors.

Figure 3-5. MLVDS (Multipoint Low Voltage Differential Signaling)

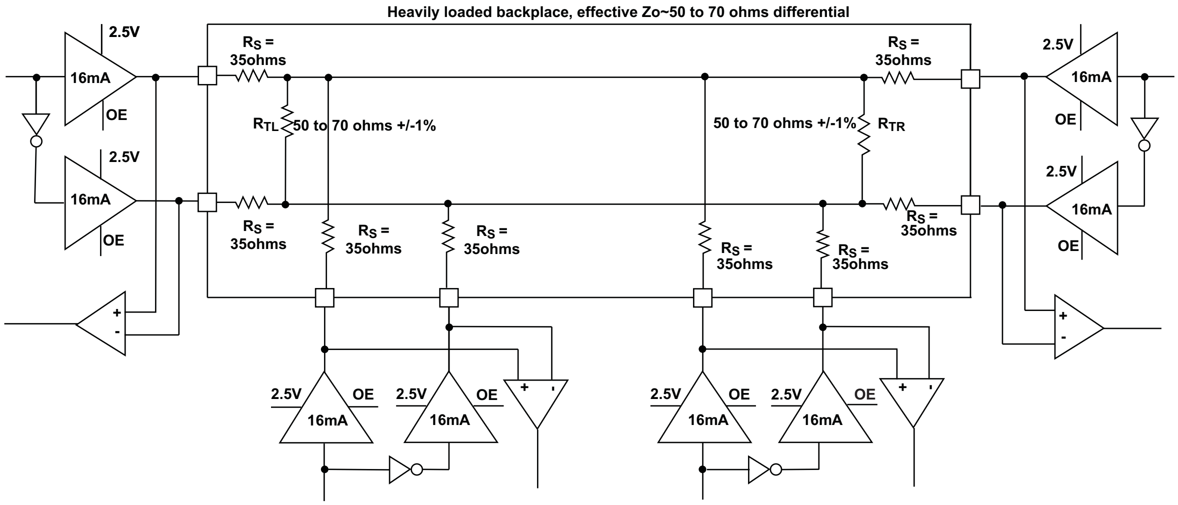


Table 3-6. MLVDS DC Conditions[1]

Parameter	Description	Typical		Units
		Zo=50Ω	Zo=70Ω	
V_{CCIO}	Output Driver Supply (+/-5%)	2.50	2.50	V
Z_{OUT}	Driver Impedance	10.00	10.00	Ω
R_S	Driver Series Resistor (+/-1%)	35.00	35.00	Ω
R_{TL}	Driver Parallel Resistor (+/-1%)	50.00	70.00	Ω
R_{TR}	Receiver Termination (+/-1%)	50.00	70.00	Ω
V_{OH}	Output High Voltage	1.52	1.60	V
V_{OL}	Output Low Voltage	0.98	0.90	V
V_{OD}	Output Differential Voltage	0.54	0.70	V
V_{CM}	Output Common Mode Voltage	1.25	1.25	V
I_{DC}	DC Output Current	21.74	20.00	mA

1. For input buffer, see LVDS table.

For further information about LVPECL, RSDS, MLVDS, BLVDS and other differential interfaces please see the list of additional technical information at the end of this data sheet.

sysCLOCK GPLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
f_{IN}	Input Clock Frequency (CLKI, CLKFB)	Without external capacitor	20	—	420	MHz
		With external capacitor[5, 6]	2	—	420	MHz
f_{OUT}	Output Clock Frequency (CLKOP, CLKOS)	Without external capacitor	20	—	420	MHz
		With external capacitor[5]	5	—	50	MHz
f_{OUT2}	K-Divider Output Frequency (CLKOK)	Without external capacitor	0.156	—	210	MHz
		With external capacitor[5]	0.039	—	25	MHz
f_{VCO}	PLL VCO Frequency		640	—	1280	MHz
f_{PFD}	Phase Detector Input Frequency	Without external capacitor	20	—	420	MHz
		With external capacitor[5, 6]	2	—	50	MHz
AC Characteristics						
t_{DT}	Output Clock Duty Cycle	Default duty cycle selected[3]	45	50	55	%
t_{PH}[4]	Output Phase Accuracy		—	—	±0.05	UI
t_{OPJIT}[1]	Output Clock Period Jitter	$f_{OUT} \geq 100$ MHz	—	—	±125	ps
		$50 \leq f_{OUT} < 100$ MHz	—		0.025	UIPP
		$f_{OUT} < 50$ MHz	—	—	0.04	UIPP
t_{SK}	Input Clock to Output Clock Skew	N/M = integer	—	—	±250	ps
t_W	Output Clock Pulse Width	At 90% or 10%	1	—	—	ns
t_{LOCK}[2]	PLL Lock-in Time	Without external capacitor	—	—	150	µs
		With external capacitor[5]	—	—	500	µs
t_{PA}	Programmable Delay Unit		85	130	360	ps
t_{IPJIT}	Input Clock Period Jitter		—	—	±200	ps
t_{FBKDLY}	External Feedback Delay		—	—	10	ns
t_{HI}	Input Clock High Time	90% to 90%	0.5	—	—	ns
t_{LO}	Input Clock Low Time	10% to 10%	0.5	—	—	ns
t_{RST}	RST Pulse Width (RESETM/RESETK)		15	—	—	ns
	Reset Signal Pulse Width (CNTRST)	Without external capacitor	500	—	—	ns
		With external capacitor[5]	20	—	—	µs

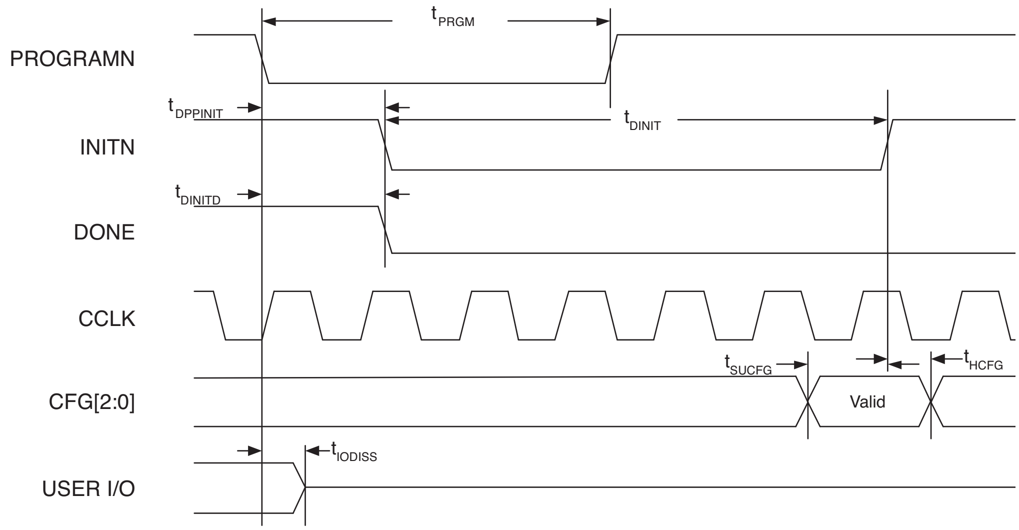
1. Jitter sample is taken over 10,000 samples of the primary PLL output with clean reference clock and no additional I/O pins toggling.
2. Output clock is valid after t_{LOCK} for PLL reset and dynamic delay adjustment.
3. Using LVDS output buffers.
4. Relative to CLKOP.
5. Value of external capacitor: 5.6 nF ±20%, NPO dielectric, ceramic chip capacitor, 1206 or smaller package, connected to PLLCAP pin.
6. f_{OUT} (max) = f_{IN} * 10 for f_{IN} < 5MHz.

Table 3-13. Periodic Receiver Jitter Tolerance Specification[1]

Description	Frequency	Condition	Min.	Typ.	Max.	Units
Periodic	3.125 Gbps	600 mV differential eye	—	—	0.20	UI, p-p
	2.5 Gbps	600 mV differential eye	—	—	0.22	UI, p-p
	1.25 Gbps	600 mV differential eye	—	—	0.20	UI, p-p
	250 Mbps[2]	600 mV differential eye	—	—	0.08	UI, p-p

1. Values are measured with PRBS 2^7-1, all channels operating.
2. Jitter specification is limited by measurement equipment capability.

Figure 3-18. Configuration from PROGRAMN Timing



1. The CFG pins are normally static (hard wired)

Figure 3-19. Wake-Up Timing

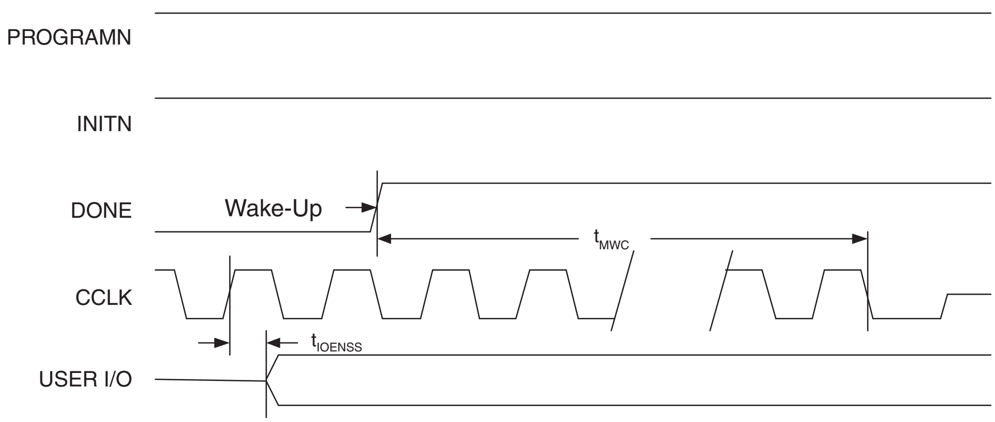
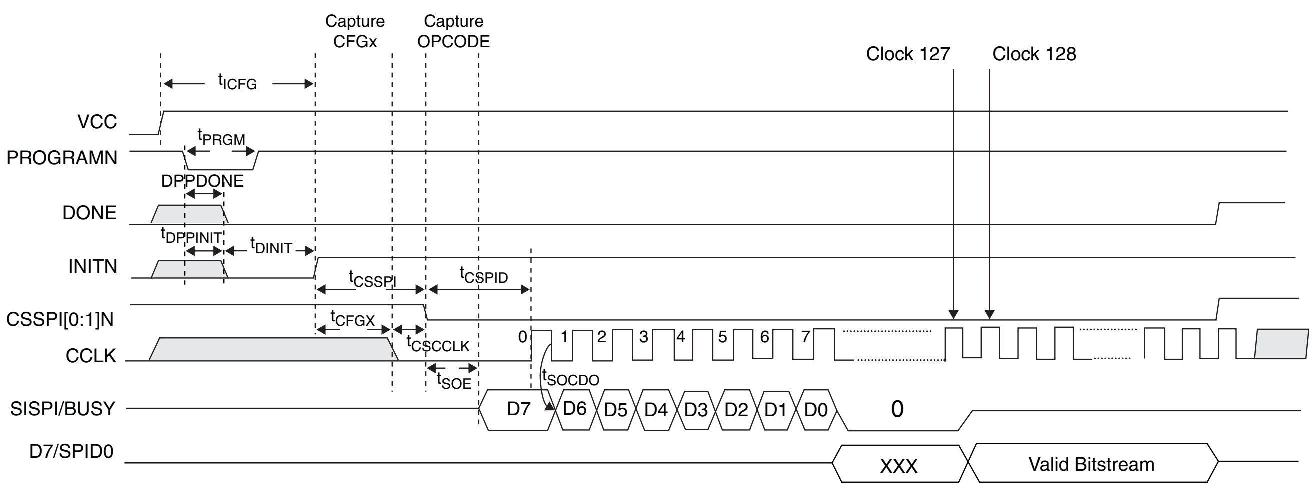


Figure 3-20. SPI/SPIm Configuration Waveforms



LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U3	PL55A	6	LDQ56	T	PL74A	6	LDQ75	T
U4	PL55B	6	LDQ56	C	PL74B	6	LDQ75	C
GNDIO	GNDIO6	-			GNDIO6	-		
Y1	PL56A	6	LDQS56	T (LVDS)*	PL75A	6	LDQS75	T (LVDS)*
W1	PL56B	6	LDQ56	C (LVDS)*	PL75B	6	LDQ75	C (LVDS)*
R7	PL57A	6	LDQ56	T	PL76A	6	LDQ75	T
VCCIO	VCCIO6	6			VCCIO	6		
T7	PL57B	6	LDQ56	C	PL76B	6	LDQ75	C
V4	PL58A	6	LDQ56	T (LVDS)*	PL77A	6	LDQ75	T (LVDS)*
V3	PL58B	6	LDQ56	C (LVDS)*	PL77B	6	LDQ75	C (LVDS)*
AA2	PL59A	6	LDQ56	T	PL78A	6	LDQ75	T
GNDIO	GNDIO6	-			GNDIO6	-		
AA1	PL59B	6	LDQ56	C	PL78B	6	LDQ75	C
U7	TCK	-			TCK	-		
U5	TDI	-			TDI	-		
V5	TMS	-			TMS	-		
V6	TDO	-			TDO	-		
T8	VCCJ	-			VCCJ	-		
Y3	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T
Y2	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C
W4	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T
W3	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C
W5	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T
W6	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO	5		
AB3	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T
AB2	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C
GNDIO	GNDIO5	-			GNDIO5	-		
Y4	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T
AA3	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C
AB5	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T
AB4	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C
AA5	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T
Y5	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO	5		
AB6	PB9A	5	BDQ6	T	PB9A	5	BDQ6	T
AA6	PB9B	5	BDQ6	C	PB9B	5	BDQ6	C
GNDIO	GNDIO5	-			GNDIO5	-		
VCCIO	VCCIO5	5			VCCIO	5		
W7	PB20A	5	BDQ24	T	PB29A	5	BDQ33	T
W8	PB20B	5	BDQ24	C	PB29B	5	BDQ33	C
Y6	PB21A	5	BDQ24	T	PB30A	5	BDQ33	T
Y7	PB21B	5	BDQ24	C	PB30B	5	BDQ33	C
AA7	PB22A	5	BDQ24	T	PB31A	5	BDQ33	T
VCCIO	VCCIO5	5			VCCIO	5		
AB7	PB22B	5	BDQ24	C	PB31B	5	BDQ33	C

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

	LFE2-50E/SE				LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
L23	VCCIO2	2			VCCIO2	2		
M17	VCCIO2	2			VCCIO2	2		
M18	VCCIO2	2			VCCIO2	2		
AA23	VCCIO3	3			VCCIO3	3		
R17	VCCIO3	3			VCCIO3	3		
R18	VCCIO3	3			VCCIO3	3		
T23	VCCIO3	3			VCCIO3	3		
V20	VCCIO3	3			VCCIO3	3		
AC16	VCCIO4	4			VCCIO4	4		
AC21	VCCIO4	4			VCCIO4	4		
U15	VCCIO4	4			VCCIO4	4		
V15	VCCIO4	4			VCCIO4	4		
Y18	VCCIO4	4			VCCIO4	4		
AC11	VCCIO5	5			VCCIO5	5		
AC6	VCCIO5	5			VCCIO5	5		
U12	VCCIO5	5			VCCIO5	5		
V12	VCCIO5	5			VCCIO5	5		
Y9	VCCIO5	5			VCCIO5	5		
AA4	VCCIO6	6			VCCIO6	6		
R10	VCCIO6	6			VCCIO6	6		
R9	VCCIO6	6			VCCIO6	6		
T4	VCCIO6	6			VCCIO6	6		
V7	VCCIO6	6			VCCIO6	6		
F4	VCCIO7	7			VCCIO7	7		
J7	VCCIO7	7			VCCIO7	7		
L4	VCCIO7	7			VCCIO7	7		
M10	VCCIO7	7			VCCIO7	7		
M9	VCCIO7	7			VCCIO7	7		
AE25	VCCIO8	8			VCCIO8	8		
V18	VCCIO8	8			VCCIO8	8		
J10	VCCAUX	-			VCCAUX	-		
J11	VCCAUX	-			VCCAUX	-		
J16	VCCAUX	-			VCCAUX	-		
J17	VCCAUX	-			VCCAUX	-		
K18	VCCAUX	-			VCCAUX	-		
K9	VCCAUX	-			VCCAUX	-		
L18	VCCAUX	-			VCCAUX	-		
L9	VCCAUX	-			VCCAUX	-		
T18	VCCAUX	-			VCCAUX	-		
T9	VCCAUX	-			VCCAUX	-		
U18	VCCAUX	-			VCCAUX	-		
U9	VCCAUX	-			VCCAUX	-		
V10	VCCAUX	-			VCCAUX	-		
V11	VCCAUX	-			VCCAUX	-		
V16	VCCAUX	-			VCCAUX	-		
V17	VCCAUX	-			VCCAUX	-		

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
G5	VCCIO7	7		
J8	VCCIO7	7		
K4	VCCIO7	7		
AA22	VCCIO8	8		
U19	VCCIO8	8		
H11	VCCAUX	-		
H12	VCCAUX	-		
L15	VCCAUX	-		
L8	VCCAUX	-		
M15	VCCAUX	-		
M8	VCCAUX	-		
R11	VCCAUX	-		
R12	VCCAUX	-		
A1	GND	-		
A10	GND	-		
A16	GND	-		
A22	GND	-		
AA19	GND	-		
AA4	GND	-		
AB1	GND	-		
AB22	GND	-		
B13	GND	-		
B19	GND	-		
B4	GND	-		
D16	GND	-		
D2	GND	-		
D21	GND	-		
D7	GND	-		
G19	GND	-		
G4	GND	-		
H10	GND	-		
H13	GND	-		
J14	GND	-		
J9	GND	-		
K10	GND	-		
K11	GND	-		
K12	GND	-		
K13	GND	-		
K15	GND	-		
K20	GND	-		
K3	GND	-		
K8	GND	-		
L10	GND	-		

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
D2	PL9A	7	VREF2_7/LDQ6	T	PL9A	7	VREF2_7	T
D3	PL9B	7	VREF1_7/LDQ6	C	PL9B	7	VREF1_7	C
GNDIO	GNDIO7	-			GNDIO7	-		
J8	PL11A	7	LUM0_SPLLT_IN_A	T (LVDS)*	PL11A	7	LUM0_SPLLT_IN_A/LDQ15	T (LVDS)*
H7	PL11B	7	LUM0_SPLLC_IN_A	C (LVDS)*	PL11B	7	LUM0_SPLLC_IN_A/LDQ15	C (LVDS)*
E3	PL12A	7	LUM0_SPLLT_FB_A	T	PL12A	7	LUM0_SPLLT_FB_A/LDQ15	T
E4	PL12B	7	LUM0_SPLLC_FB_A	C	PL12B	7	LUM0_SPLLC_FB_A/LDQ15	C
GNDIO	GNDIO7	-			-	-		
G6	PL13A	7		T (LVDS)*	PL13A	7	LDQ15	T (LVDS)*
F5	PL13B	7		C (LVDS)*	PL13B	7	LDQ15	C (LVDS)*
E2	PL14A	7		T	PL14A	7	LDQ15	T
D1	PL14B	7		C	PL14B	7	LDQ15	C
-	-	-			GNDIO7	-		
G5	NC	-			PL15A	7	LDQS15	T (LVDS)*
G4	NC	-			PL15B	7	LDQ15	C (LVDS)*
K7	NC	-			PL16A	7	LDQ15	T
K8	NC	-			PL16B	7	LDQ15	C
E1	NC	-			PL17A	7	LDQ15	T (LVDS)*
F2	NC	-			PL17B	7	LDQ15	C (LVDS)*
F1	NC	-			PL18A	7	LDQ15	T
-	-	-			GNDIO7	-		
G3	NC	-			PL18B	7	LDQ15	C
H5	PL15A	7		T (LVDS)*	PL21A	7		T (LVDS)*
H4	PL15B	7		C (LVDS)*	PL21B	7		C (LVDS)*
J5	PL16A	7		T	PL22A	7		T
J4	PL16B	7		C	PL22B	7		C
GNDIO	GNDIO7	-			GNDIO7	-		
G2	NC	-			PL24A	7	LDQ28	T (LVDS)*
G1	NC	-			PL24B	7	LDQ28	C (LVDS)*
L9	NC	-			PL25A	7	LDQ28	T
L7	NC	-			PL25B	7	LDQ28	C
K6	NC	-			PL26A	7	LDQ28	T (LVDS)*
K5	NC	-			PL26B	7	LDQ28	C (LVDS)*
L8	NC	-			PL27A	7	LDQ28	T
L6	NC	-			PL27B	7	LDQ28	C
-	-	-			GNDIO7	-		
H3	PL18A	7		T (LVDS)*	PL28A	7	LDQS28	T (LVDS)*
H2	PL18B	7		C (LVDS)*	PL28B	7	LDQ28	C (LVDS)*
N8	PL19A	7		T	PL29A	7	LDQ28	T
M9	PL19B	7		C	PL29B	7	LDQ28	C
J3	PL20A	7		T (LVDS)*	PL30A	7	LDQ28	T (LVDS)*
VCCIO	VCCIO7	7			-	-		
J2	PL20B	7		C (LVDS)*	PL30B	7	LDQ28	C (LVDS)*
H1	PL21A	7		T	PL31A	7	LDQ28	T
GNDIO	GNDIO7	-			GNDIO7	-		
J1	PL21B	7		C	PL31B	7	LDQ28	C
-	-	-			-	-		
-	-	-			-	-		

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
T29	PR48B	3	RDQ52	C (LVDS)*	PR60B	3	RDQ64	C (LVDS)*
T28	PR48A	3	RDQ52	T (LVDS)*	PR60A	3	RDQ64	T (LVDS)*
R23	PR46B	3	RLM3_SPLLC_FB_A	C	PR58B	3	RLM3_SPLLC_FB_A/RDQ55	C
GNDIO	GNDIO3	-			GNDIO3	-		
VCCIO	VCCIO3	3			-	-		
R22	PR46A	3	RLM3_SPLLT_FB_A	T	PR58A	3	RLM3_SPLLT_FB_A/RDQ55	T
P30	PR45B	3	RLM3_SPLLC_IN_A	C (LVDS)*	PR57B	3	RLM3_SPLLC_IN_A/RDQ55	C (LVDS)*
R29	PR45A	3	RLM3_SPLLT_IN_A	T (LVDS)*	PR57A	3	RLM3_SPLLT_IN_A/RDQ55	T (LVDS)*
T27	PR44B	3		C	PR56B	3	RDQ55	C
-	-	-			VCCIO3	3		
T26	PR44A	3		T	PR56A	3	RDQ55	T
GNDIO	GNDIO3	-			GNDIO3	-		
N30	PR43B	3		C (LVDS)*	PR53B	3	RDQ55	C (LVDS)*
N29	PR43A	3		T (LVDS)*	PR53A	3	RDQ55	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO3	3		
R27	PR42B	3	VREF2_3	C	PR52B	3	VREF2_3/RDQ55	C
R28	PR42A	3	VREF1_3	T	PR52A	3	VREF1_3/RDQ55	T
P29	PR41B	3	PCLKC3_0	C (LVDS)*	PR51B	3	PCLKC3_0/RDQ55	C (LVDS)*
P28	PR41A	3	PCLKT3_0	T (LVDS)*	PR51A	3	PCLKT3_0/RDQ55	T (LVDS)*
M30	PR39B	2	PCLKC2_0/RDQ36	C	PR49B	2	PCLKC2_0/RDQ46	C
M29	PR39A	2	PCLKT2_0/RDQ36	T	PR49A	2	PCLKT2_0/RDQ46	T
GNDIO	GNDIO2	-			GNDIO2	-		
P23	PR38B	2	RDQ36	C (LVDS)*	PR48B	2	RDQ46	C (LVDS)*
P24	PR38A	2	RDQ36	T (LVDS)*	PR48A	2	RDQ46	T (LVDS)*
R26	PR37B	2	RDQ36	C	PR47B	2	RDQ46	C
P27	PR37A	2	RDQ36	T	PR47A	2	RDQ46	T
VCCIO	VCCIO2	2			VCCIO2	2		
P25	PR36B	2	RDQ36	C (LVDS)*	PR46B	2	RDQ46	C (LVDS)*
P26	PR36A	2	RDQS36	T (LVDS)*	PR46A	2	RDQS46	T (LVDS)*
K30	PR35B	2	RDQ36	C	PR45B	2	RDQ46	C
GNDIO	GNDIO2	-			GNDIO2	-		
K29	PR35A	2	RDQ36	T	PR45A	2	RDQ46	T
N22	PR34B	2	RDQ36	C (LVDS)*	PR44B	2	RDQ46	C (LVDS)*
P22	PR34A	2	RDQ36	T (LVDS)*	PR44A	2	RDQ46	T (LVDS)*
J30	PR33B	2	RUM3_SPLLC_FB_A/RDQ36	C	PR43B	2	RUM3_SPLLC_FB_A/RDQ46	C
VCCIO	VCCIO2	2			VCCIO2	2		
J29	PR33A	2	RUM3_SPLLT_FB_A/RDQ36	T	PR43A	2	RUM3_SPLLT_FB_A/RDQ46	T
N24	PR32B	2	RUM3_SPLLC_IN_A/RDQ36	C (LVDS)*	PR42B	2	RUM3_SPLLC_IN_A/RDQ46	C (LVDS)*
N23	PR32A	2	RUM3_SPLLT_IN_A/RDQ36	T (LVDS)*	PR42A	2	RUM3_SPLLT_IN_A/RDQ46	T (LVDS)*
N25	PR30B	2	RDQ27	C	PR40B	2	RDQ37	C
N26	PR30A	2	RDQ27	T	PR40A	2	RDQ37	T
GNDIO	GNDIO2	-			GNDIO2	-		
M27	PR29B	2	RDQ27	C (LVDS)*	PR39B	2	RDQ37	C (LVDS)*
M28	PR29A	2	RDQ27	T (LVDS)*	PR39A	2	RDQ37	T (LVDS)*
H30	PR28B	2	RDQ27	C	PR38B	2	RDQ37	C
G30	PR28A	2	RDQ27	T	PR38A	2	RDQ37	T
VCCIO	VCCIO2	2			VCCIO2	2		
M25	PR27B	2	RDQ27	C (LVDS)*	PR37B	2	RDQ37	C (LVDS)*

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
D19	PT93B	1		C
E18	PT93A	1		T
D18	PT92B	1		C
C17	PT92A	1		T
A17	PT91B	1		C
B17	PT91A	1		T
GNDIO	GNDIO1	-		
VCCIO	VCCIO1	1		
J18	PT75B	1		C
J19	PT75A	1		T
H17	PT74B	1		C
J17	PT74A	1		T
F18	PT73B	1		C
F17	PT73A	1		T
GNDIO	GNDIO1	-		
A16	PT72B	1		C
B16	PT72A	1		T
G17	PT71B	1		C
G16	PT71A	1		T
VCCIO	VCCIO1	1		
H16	PT70B	1		C
F16	PT70A	1		T
J16	PT69B	1		C
G15	PT69A	1		T
GNDIO	GNDIO1	-		
C16	PT68B	1		C
D16	PT68A	1		T
J15	PT67B	1		C
H15	PT67A	1		T
VCCIO	VCCIO1	1		
A15	PT66B	1	VREF2_1	C
B15	PT66A	1	VREF1_1	T
F15	PT65B	1	PCLKC1_0	C
E16	PT65A	1	PCLKT1_0	T
C15	PT64B	0	PCLKC0_0	C
GNDIO	GNDIO0	-		
D15	PT64A	0	PCLKT0_0	T
C14	PT63B	0	VREF2_0	C
E15	PT63A	0	VREF1_0	T
G14	PT62B	0		C
VCCIO	VCCIO0	0		
J14	PT62A	0		T
F14	PT61B	0		C

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE					LFE2M100E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U8	PL43B	7	LUM3_SPLLC_FB_A/LDQ46	C	PL51B	7	LUM3_SPLLC_FB_A/LDQ54	C
VCCIO	VCCIO7	7			VCCIO7	7		
T6	PL44A	7	LDQ46	T (LVDS)*	PL52A	7	LDQ54	T (LVDS)*
R6	PL44B	7	LDQ46	C (LVDS)*	PL52B	7	LDQ54	C (LVDS)*
U9	PL45A	7	LDQ46	T	PL53A	7	LDQ54	T
T7	PL45B	7	LDQ46	C	PL53B	7	LDQ54	C
GNDIO	GNDIO7	-			GNDIO7	-		
U5	PL46A	7	LDQS46	T (LVDS)*	PL54A	7	LDQS54	T (LVDS)*
U6	PL46B	7	LDQ46	C (LVDS)*	PL54B	7	LDQ54	C (LVDS)*
U7	PL47A	7	LDQ46	T	PL55A	7	LDQ54	T
VCCIO	VCCIO7	7			VCCIO7	7		
V9	PL47B	7	LDQ46	C	PL55B	7	LDQ54	C
V11	PL48A	7	LDQ46	T (LVDS)*	PL56A	7	LDQ54	T (LVDS)*
V10	PL48B	7	LDQ46	C (LVDS)*	PL56B	7	LDQ54	C (LVDS)*
U4	PL49A	7	PCLKT7_0/LDQ46	T	PL57A	7	PCLKT7_0/LDQ54	T
GNDIO	GNDIO7	-			GNDIO7	-		
U3	PL49B	7	PCLKC7_0/LDQ46	C	PL57B	7	PCLKC7_0/LDQ54	C
U2	PL51A	6	PCLKT6_0/LDQ55	T (LVDS)*	PL59A	6	PCLKT6_0/LDQ63	T (LVDS)*
U1	PL51B	6	PCLKC6_0/LDQ55	C (LVDS)*	PL59B	6	PCLKC6_0/LDQ63	C (LVDS)*
V5	PL52A	6	VREF2_6/LDQ55	T	PL60A	6	VREF2_6/LDQ63	T
V6	PL52B	6	VREF1_6/LDQ55	C	PL60B	6	VREF1_6/LDQ63	C
V7	PL53A	6	LDQ55	T (LVDS)*	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6			VCCIO6	6		
V8	PL53B	6	LDQ55	C (LVDS)*	PL61B	6	LDQ63	C (LVDS)*
V4	PL54A	6	LDQ55	T	PL62A	6	LDQ63	T
V3	PL54B	6	LDQ55	C	PL62B	6	LDQ63	C
V2	PL55A	6	LDQS55	T (LVDS)*	PL63A	6	LDQS63	T (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
V1	PL55B	6	LDQ55	C (LVDS)*	PL63B	6	LDQ63	C (LVDS)*
W7	PL56A	6	LDQ55	T	PL64A	6	LDQ63	T
W5	PL56B	6	LDQ55	C	PL64B	6	LDQ63	C
VCCIO	VCCIO6	6			VCCIO6	6		
W2	PL57A	6	LLM3_SPLLT_IN_A/LDQ55	T (LVDS)*	PL65A	6	LLM4_SPLLT_IN_A/LDQ63	T (LVDS)*
W1	PL57B	6	LLM3_SPLLC_IN_A/LDQ55	C (LVDS)*	PL65B	6	LLM4_SPLLC_IN_A/LDQ63	C (LVDS)*
Y6	PL58A	6	LLM3_SPLLT_FB_A/LDQ55	T	PL66A	6	LLM4_SPLLT_FB_A/LDQ63	T
W6	PL58B	6	LLM3_SPLLC_FB_A/LDQ55	C	PL66B	6	LLM4_SPLLC_FB_A/LDQ63	C
GNDIO	GNDIO6	-			GNDIO6	-		
Y1	PL60A	6	LDQ64	T (LVDS)*	PL68A	6	LDQ72	T (LVDS)*
Y2	PL60B	6	LDQ64	C (LVDS)*	PL68B	6	LDQ72	C (LVDS)*
Y7	PL61A	6	LDQ64	T	PL69A	6	LDQ72	T
Y5	PL61B	6	LDQ64	C	PL69B	6	LDQ72	C
VCCIO	VCCIO6	6			VCCIO6	6		
W10	PL62A	6	LDQ64	T (LVDS)*	PL70A	6	LDQ72	T (LVDS)*
Y8	PL62B	6	LDQ64	C (LVDS)*	PL70B	6	LDQ72	C (LVDS)*
Y4	PL63A	6	LDQ64	T	PL71A	6	LDQ72	T
Y3	PL63B	6	LDQ64	C	PL71B	6	LDQ72	C
GNDIO	GNDIO6	-			GNDIO6	-		
AA1	PL64A	6	LDQS64	T (LVDS)*	PL72A	6	LDQS72	T (LVDS)*
AA2	PL64B	6	LDQ64	C (LVDS)*	PL72B	6	LDQ72	C (LVDS)*

LatticeECP2/M Family Data Sheet
Ordering Information

July 2012 **Data Sheet DS1006**

LatticeECP2 Part Number Description

LFE2 – XX XE – X XXXXXX X

Device Family
ECP2 (LatticeECP2 FPGA)

Logic Capacity
6 = 6K LUTs
12 = 12K LUTs
20 = 20K LUTs
35 = 35K LUTs
50 = 50K LUTs
70 = 70K LUTs

Encryption
S = Security Series (Encryption Feature)
Blank = Standard Series (No Encryption)

Supply Voltage
E = 1.2V

Grade
C = Commercial
I = Industrial

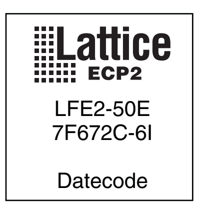
Package
T144 = 144-pin TQFP
Q208 = 208-pin PQFP
F256 = 256-ball fpBGA
F484 = 484-ball fpBGA
F672 = 672-ball fpBGA
F900 = 900-ball fpBGA

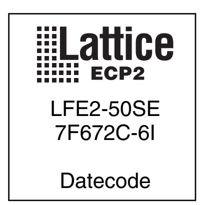
TN144 = 144-pin Lead-Free TQFP
QN208 = 208-pin Lead-Free PQFP
FN256 = 256-ball Lead-Free fpBGA
FN484 = 484-ball Lead-Free fpBGA
FN672 = 672-ball Lead-Free fpBGA
FN900 = 900-ball Lead-Free fpBGA

Speed
5 = Slowest
6
7 = Fastest

Ordering Information

Note:þLatticeECP2 devices are dual marked. For example, the commercial speed grade LFE2-50E-7F672C is also marked with industrial grade -6I (LFE2-50E-6F672I). The commercial grade is one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade does not have industrial markings. The markings appear as follows:





Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20SE-5F484I	304	1.2V	-5	fpBGA	484	Ind	20
LFE2M20SE-6F484I	304	1.2V	-6	fpBGA	484	Ind	20
LFE2M20SE-5F256I	140	1.2V	-5	fpBGA	256	Ind	20
LFE2M20SE-6F256I	140	1.2V	-6	fpBGA	256	Ind	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35SE-5F672I	410	1.2V	-5	fpBGA	672	Ind	35
LFE2M35SE-6F672I	410	1.2V	-6	fpBGA	672	Ind	35
LFE2M35SE-5F484I	303	1.2V	-5	fpBGA	484	Ind	35
LFE2M35SE-6F484I	303	1.2V	-6	fpBGA	484	Ind	35
LFE2M35SE-5F256I	140	1.2V	-5	fpBGA	256	Ind	35
LFE2M35SE-6F256I	140	1.2V	-6	fpBGA	256	Ind	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50SE-5F900I	410	1.2V	-5	fpBGA	900	Ind	50
LFE2M50SE-6F900I	410	1.2V	-6	fpBGA	900	Ind	50
LFE2M50SE-5F672I	372	1.2V	-5	fpBGA	672	Ind	50
LFE2M50SE-6F672I	372	1.2V	-6	fpBGA	672	Ind	50
LFE2M50SE-5F484I	270	1.2V	-5	fpBGA	484	Ind	50
LFE2M50SE-6F484I	270	1.2V	-6	fpBGA	484	Ind	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70SE-5F1152I	436	1.2V	-5	fpBGA	1152	Ind	70
LFE2M70SE-6F1152I	436	1.2V	-6	fpBGA	1152	Ind	70
LFE2M70SE-5F900I	416	1.2V	-5	fpBGA	900	Ind	70
LFE2M70SE-6F900I	416	1.2V	-6	fpBGA	900	Ind	70

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100SE-5F1152I	520	1.2V	-5	fpBGA	1152	Ind	100
LFE2M100SE-6F1152I	520	1.2V	-6	fpBGA	1152	Ind	100
LFE2M100SE-5F900I	416	1.2V	-5	fpBGA	900	Ind	100
LFE2M100SE-6F900I	416	1.2V	-6	fpBGA	900	Ind	100

Date	Version	Section	Change Summary
June 2013 (cont.)	04.0 (cont.)	DC and Switching Characteristics	sysCLOCK SPLL Timing table – Corrected signal names for t_{RST} parameter.
			LatticeECP2/M sysCONFIG Port Timing Specifications table – added t_{SUMCDI} and t_{HMCDI} parameters.
September 2013	04.1	Architecture	Updated Selectable Master Clock (CCLK) Frequencies during Configuration table.
		DC and Switching Characteristics	Added information on f_{MAXSPI} parameter in LatticeECP2/M sysCONFIG Port Timing Specifications table.